



Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	HCS12Z
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, I ² C, SCI, SPI
Peripherals	DMA, POR, PWM, WDT
Number of I/O	28
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 40V
Data Converters	A/D 10x12b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s912zvca96f0vlf

Chapter 8

S12 Clock, Reset and Power Management Unit (S12CPMU_UHV_V7)

8.1	Introduction	215
8.1.1	Features	216
8.1.2	Modes of Operation	218
8.1.3	S12CPMU_UHV_V7 Block Diagram	221
8.2	Signal Description	223
8.2.1	RESET	223
8.2.2	EXTAL and XTAL	223
8.2.3	VSUP — Regulator Power Input Pin	223
8.2.4	VDDA, VSSA — Regulator Reference Supply Pins	223
8.2.5	VDDX, VSSX — Pad Supply Pins	223
8.2.6	VDDX has to be connected externally to VDDA.VDDC, VSSC — CANPHY Supply Pin	224
8.2.7	BCTL — Base Control Pin for external PNP	224
8.2.8	BCTLC — Base Control Pin for external PNP for VDDC	224
8.2.9	VSS — Core Logic Ground Pin	224
8.2.10	VDD — Internal Regulator Output Supply (Core Logic)	224
8.2.11	VDDF — Internal Regulator Output Supply (NVM Logic)	224
8.2.12	API_EXTCLK — API external clock output pin	224
8.2.13	TEMPSENSE — Internal Temperature Sensor Output Voltage	225
8.3	Memory Map and Registers	226
8.3.1	Module Memory Map	226
8.3.2	Register Descriptions	228
8.4	Functional Description	266
8.4.1	Phase Locked Loop with Internal Filter (PLL)	266
8.4.2	Startup from Reset	268
8.4.3	Stop Mode using PLLCLK as source of the Bus Clock	268
8.4.4	Full Stop Mode using Oscillator Clock as source of the Bus Clock	269
8.4.5	External Oscillator	270
8.4.6	System Clock Configurations	271
8.5	Resets	272
8.5.1	General	272
8.5.2	Description of Reset Operation	273
8.5.3	Oscillator Clock Monitor Reset	273
8.5.4	PLL Clock Monitor Reset	273
8.5.5	Computer Operating Properly Watchdog (COP) Reset	274
8.5.6	Power-On Reset (POR)	275
8.5.7	Low-Voltage Reset (LVR)	275
8.6	Interrupts	276
8.6.1	Description of Interrupt Operation	276
8.7	Initialization/Application Information	278
8.7.1	General Initialization Information	278
8.7.2	Application information for COP and API usage	278
8.7.3	Application Information for PLL and Oscillator Startup	278

22.2	External Signal Description	642
22.3	Memory Map and Registers	643
22.3.1	Module Memory Map	643
22.3.2	Register Descriptions	647
22.4	Functional Description	668
22.4.1	Modes of Operation	668
22.4.2	IFR Version ID Word	668
22.4.3	Flash Block Read Access	668
22.4.4	Internal NVM resource	669
22.4.5	Flash Command Operations	670
22.4.6	Allowed Simultaneous P-Flash and EEPROM Operations	674
22.4.7	Flash Command Description	675
22.4.8	Interrupts	691
22.4.9	Wait Mode	692
22.4.10	Stop Mode	692
22.5	Security	692
22.5.1	Unsecuring the MCU using Backdoor Key Access	693
22.5.2	Unsecuring the MCU in Special Single Chip Mode using BDM	694
22.5.3	Mode and Security Effects on Flash Command Availability	694
22.6	Initialization	694

Appendix A

MCU Electrical Specifications

A.1	General	697
A.1.1	Power Pins	697
A.1.2	Pins	698
A.1.3	Current Injection	699
A.1.4	Absolute Maximum Ratings	699
A.1.5	ESD Protection and Latch-up Immunity	700
A.1.6	Operating Conditions	701
A.1.7	Power Dissipation and Thermal Characteristics	703
A.1.8	I/O Characteristics	706
A.1.9	Supply Currents	709
A.1.10	ADC Calibration Configuration	712

Appendix B

ADC Electrical Specifications

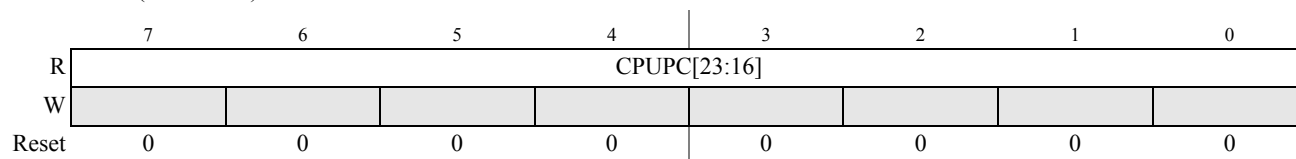
B.1	ADC Operating Characteristics	713
B.1.1	Factors Influencing Accuracy	713
B.1.2	ADC Accuracy	715

Table 4-6. MMCCCRH and MMCCRL Field Descriptions

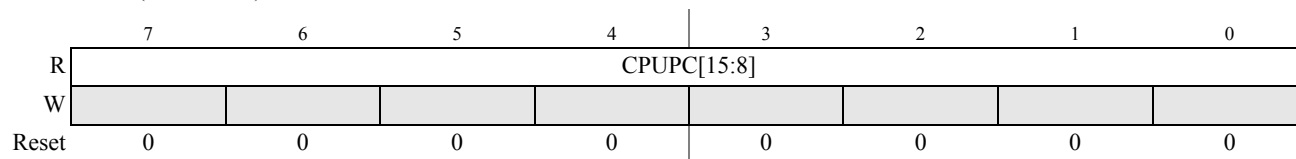
Field	Description
7 (MMCCCRH) CPUU	S12ZCPU User State Flag — This bit shows the state of the user/supervisor mode bit in the S12ZCPU's CCR at the time the access violation has occurred. The S12ZCPU user state flag is read-only; it will be automatically updated when the next error condition is flagged through the MMCEC register. This bit is undefined if the error code registers (MMCECn) are cleared.
6 (MMCCRL) CPUX	S12ZCPU X-Interrupt Mask — This bit shows the state of the X-interrupt mask in the S12ZCPU's CCR at the time the access violation has occurred. The S12ZCPU X-interrupt mask is read-only; it will be automatically updated when the next error condition is flagged through the MMCEC register. This bit is undefined if the error code registers (MMCECn) are cleared.
4 (MMCCRL) CPUI	S12ZCPU I-Interrupt Mask — This bit shows the state of the I-interrupt mask in the CPU's CCR at the time the access violation has occurred. The S12ZCPU I-interrupt mask is read-only; it will be automatically updated when the next error condition is flagged through the MMCEC register. This bit is undefined if the error code registers (MMCECn) are cleared.

4.3.2.4 Captured S12ZCPU Program Counter (MMCPCH, MMPCPM, MMCPCL)

Address: 0x0085 (MMCPCH)



Address: 0x0086 (MMPCPM)



Address: 0x0087 (MMCPCL)

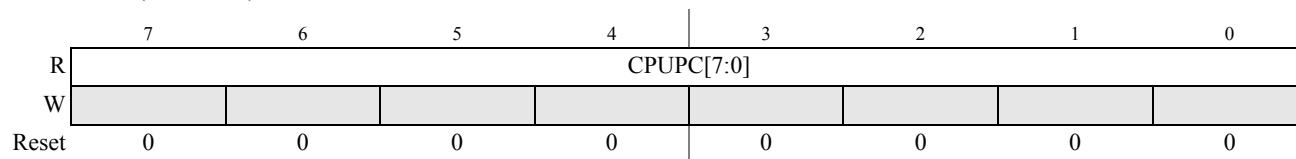


Figure 4-7. Captured S12ZCPU Program Counter (MMCPCH, MMPCPM, MMCPCL)

Read: Anytime

Write: Never

Table 4-7. MMCPCH, MMPCPM, and MMCPCL Field Descriptions

Field	Description
7–0 (MMCPCH) 7–0 (MMPCPM) 7–0 (MMCPCL) CPUPC[23:0]	S12ZCPU Program Counter Value — The CPUPC[23:0] stores the CPU's program counter value at the time the access violation occurred. CPUPC[23:0] always points to the instruction which triggered the violation. These bits are undefined if the error code registers (MMCECn) are cleared.

4.4 Functional Description

This section provides a complete functional description of the S12ZMMC module.

4.4.1 Global Memory Map

The S12ZMMC maps all on-chip resources into an 16MB address space, the global memory map. The exact resource mapping is shown in [Figure 4-8](#). The global address space is used by the S12ZCPU, ADC, and the S12ZBDC module.

8.3.2.18 Autonomous Periodical Interrupt Rate High and Low Register (CPMUAPIRH / CPMUAPIRL)

The CPMUAPIRH and CPMUAPIRL registers allow the configuration of the autonomous periodical interrupt rate.

Module Base + 0x0014

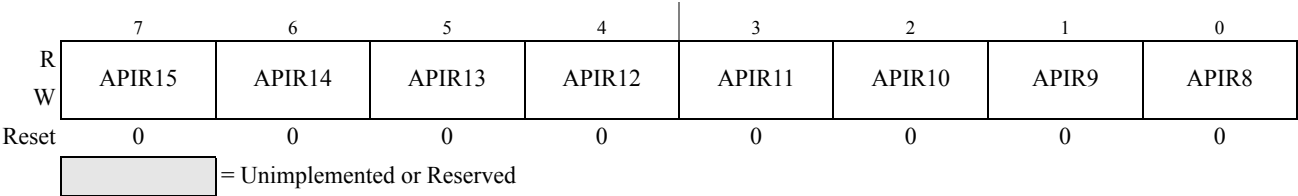


Figure 8-23. Autonomous Periodical Interrupt Rate High Register (CPMUAPIRH)

Module Base + 0x0015

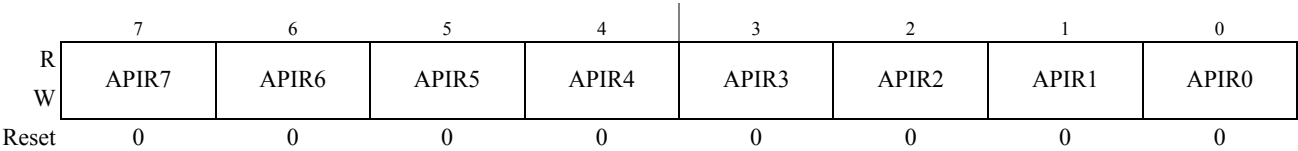


Figure 8-24. Autonomous Periodical Interrupt Rate Low Register (CPMUAPIRL)

Read: Anytime

Write: Anytime if APIFE=0, Else writes have no effect.

Table 8-21. CPMUAPIRH / CPMUAPIRL Field Descriptions

Field	Description
15-0 APIR[15:0]	Autonomous Periodical Interrupt Rate Bits — These bits define the time-out period of the API. See Table 8-22 for details of the effect of the autonomous periodical interrupt rate bits.

The period can be calculated as follows depending on logical value of the APICLK bit:

APICLK=0: Period = 2*(APIR[15:0] + 1) * (ACLK Clock Period * 2)

APICLK=1: Period = 2*(APIR[15:0] + 1) * Bus Clock Period

NOTE

For APICLK bit clear the first time-out period of the API will show a latency time between two to three f_{ACLK} cycles due to synchronous clock gate release when the API feature gets enabled (APIFE bit set).

9.4.2.11 ADC Conversion Interrupt Enable Register (ADCCONIE)

Module Base + 0x000A

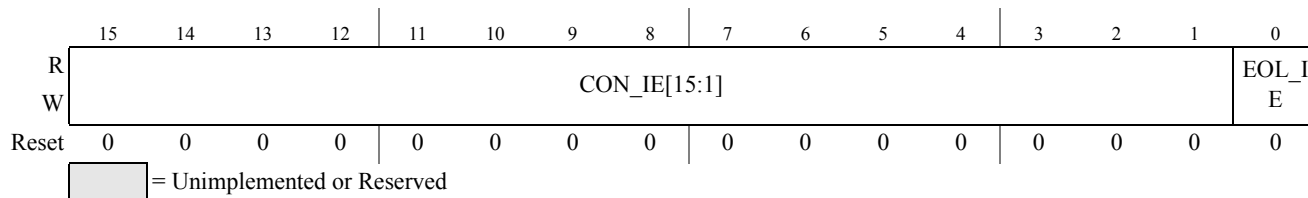


Figure 9-14. ADC Conversion Interrupt Enable Register (ADCCONIE)

Read: Anytime

Write: Anytime

Table 9-15. ADCCONIE Field Descriptions

Field	Description
15-1 CON_IE[15:1]	Conversion Interrupt Enable Bits — These bits enable the individual interrupts which can be triggered via interrupt flags CON_IF[15:1]. 0 ADC conversion interrupt disabled. 1 ADC conversion interrupt enabled.
0 EOL_IE	End Of List Interrupt Enable Bit — This bit enables the end of conversion sequence list interrupt. 0 End of list interrupt disabled. 1 End of list interrupt enabled.

Table 9-23. Analog Input Channel Select

CH_SEL[5]	CH_SEL[4]	CH_SEL[3]	CH_SEL[2]	CH_SEL[1]	CH_SEL[0]	Analog Input Channel
0	0	0	1	1	1	Reserved
0	0	1	0	0	0	Reserved
0	0	1	0	0	1	Internal_1 (Vreg_3v3 sense)
0	0	1	0	1	0	Internal_2
0	0	1	0	1	1	Internal_3
0	0	1	1	0	0	Internal_4
0	0	1	1	0	1	Internal_5
0	0	1	1	1	0	Internal_6
0	0	1	1	1	1	Internal_7
0	1	0	0	0	0	AN0
0	1	0	0	0	1	AN1
0	1	0	0	1	0	AN2
0	1	0	0	1	1	AN3
0	1	0	1	0	0	AN4
0	1	x	x	x	x	ANx
1	x	x	x	x	x	Reserved

NOTE

ANx in [Table 9-23](#) is the maximum number of implemented analog input channels on the device. Please refer to the device overview of the reference manual for details regarding number of analog input channels.

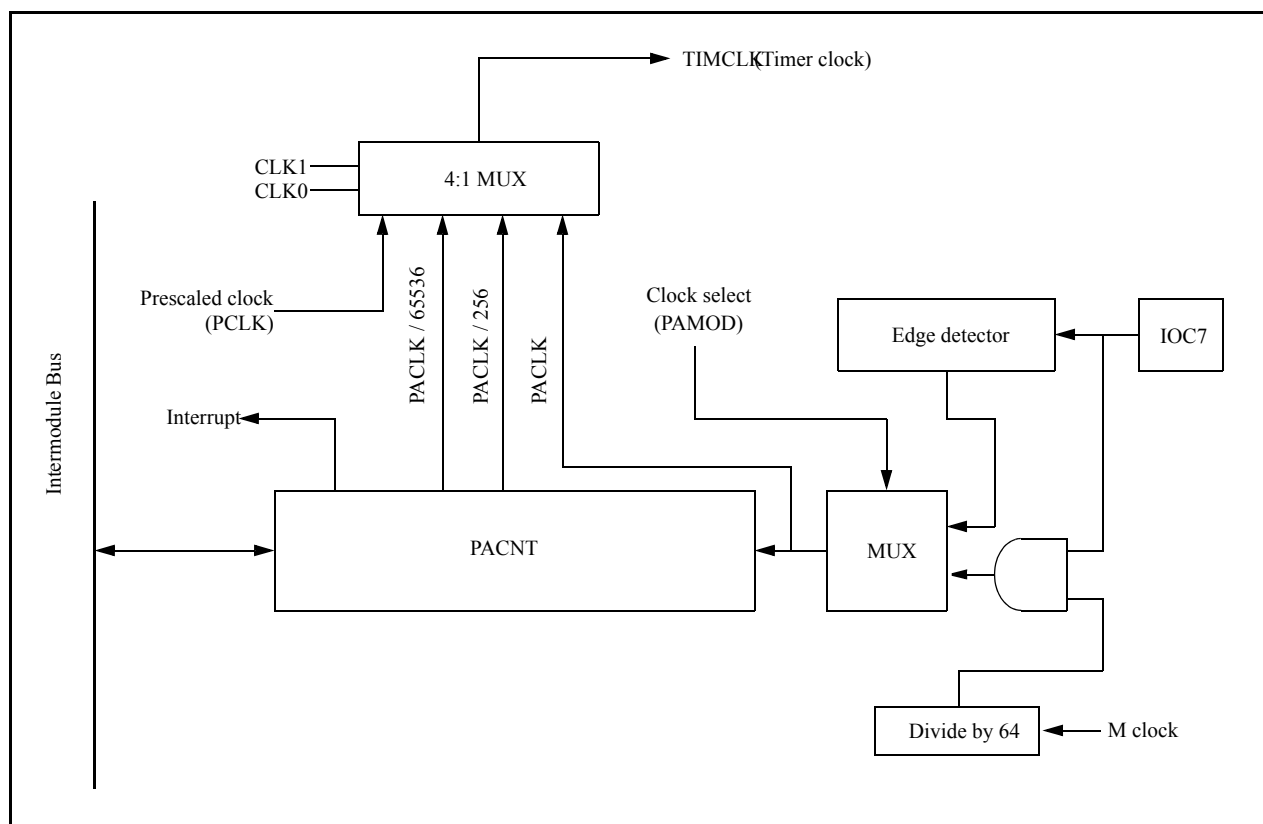


Figure 11-2. 16-Bit Pulse Accumulator Block Diagram

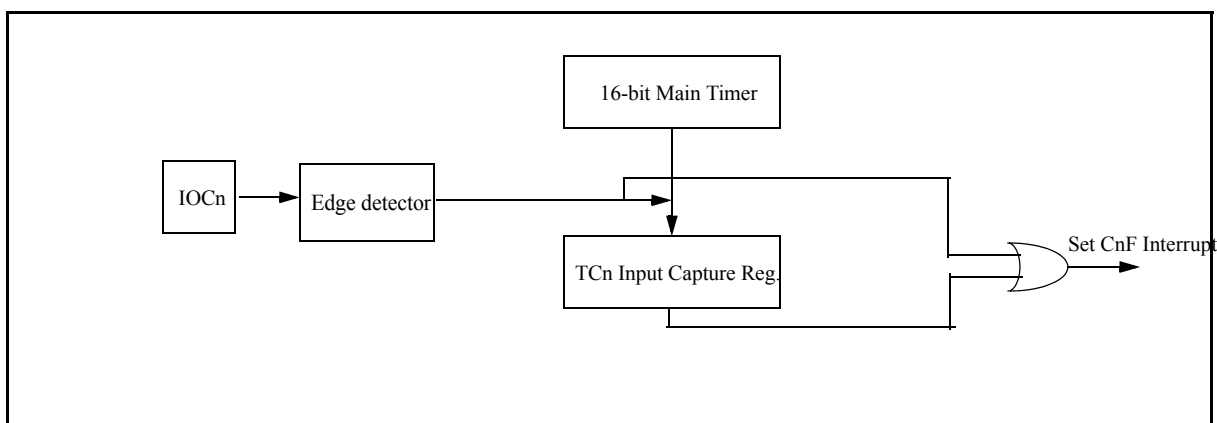


Figure 11-3. Interrupt Flag Setting

Chapter 12

Timer Module (TIM16B4CV3) Block Description

Table 12-1.

V03.00	Jan. 28, 2009		Initial version
V03.01	Aug. 26, 2009	12.1.2/12-388 Figure 1-4./1-8 1.3.2.15/1-18 12.3.2.2/12-391 , 1.3.2.3/1-8 , Chapter 12/12-38 7 , 12.4.3/12-403	<ul style="list-style-type: none">- Correct typo: TSCR ->TSCR1;- Correct typo: ECTxxx->TIMxxx- Correct reference: Figure 1-25 -> Figure 12-22- Add description, “a counter overflow when TTOV[7] is set”, to be the condition of channel 7 override event.- Phrase the description of OC7M to make it more explicit
V03.02	Apr,12,2010	12.3.2.6/12-394 12.3.2.9/12-396 12.4.3/12-403	<ul style="list-style-type: none">-Add Table 1-10-update TCRE bit description-add Figure 1-31
V03.03	Jan,14,2013		<ul style="list-style-type: none">-single source generate different channel guide

12.1 Introduction

The basic scalable timer consists of a 16-bit, software-programmable counter driven by a flexible programmable prescaler.

This timer can be used for many purposes, including input waveform measurements while simultaneously generating an output waveform.

This timer could contain up to 4 input capture/output compare channels . The input capture function is used to detect a selected transition edge and record the time. The output compare function is used for generating output signals or for timer software delays.

A full access for the counter registers or the input capture/output compare registers should take place in one clock cycle. Accessing high byte and low byte separately for all of these registers may not yield the same result as accessing them in one word.

12.1.1 Features

The TIM16B4CV3 includes these distinctive features:

- Up to 4 channels available. (refer to device specification for exact number)
- All channels have same input capture/output compare functionality.
- Clock prescaling.

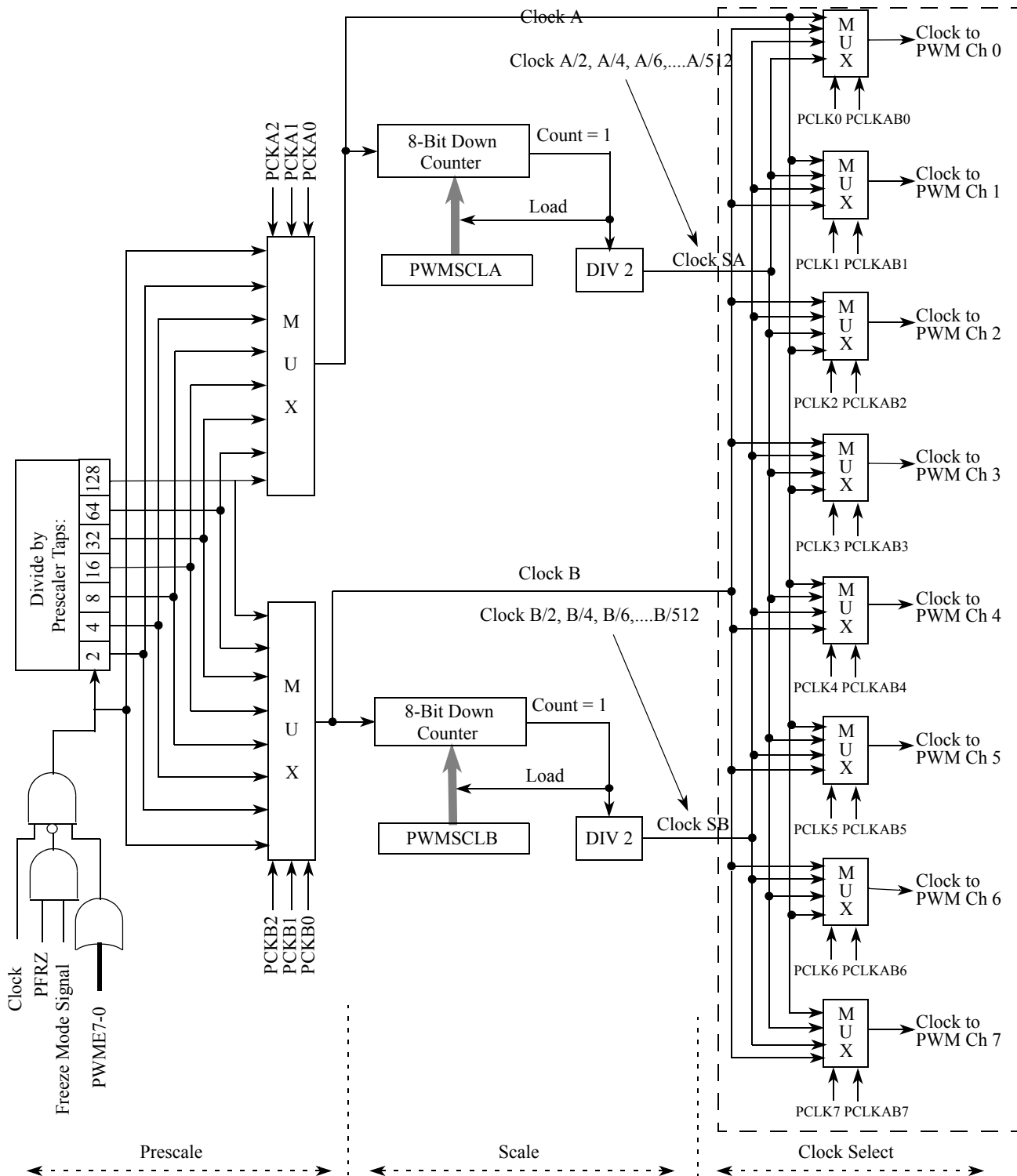


Figure 13-15. PWM Clock Select Block Diagram

- For channels 0, 1, 4, and 5 the clock choices are clock A.
- For channels 2, 3, 6, and 7 the clock choices are clock B.

13.6 Interrupts

The PWM module has no interrupt.

14.4.3 Data Format

The SCI uses the standard NRZ mark/space data format. When Infrared is enabled, the SCI uses RZI data format where zeroes are represented by light pulses and ones remain low. See [Figure 14-15](#) below.

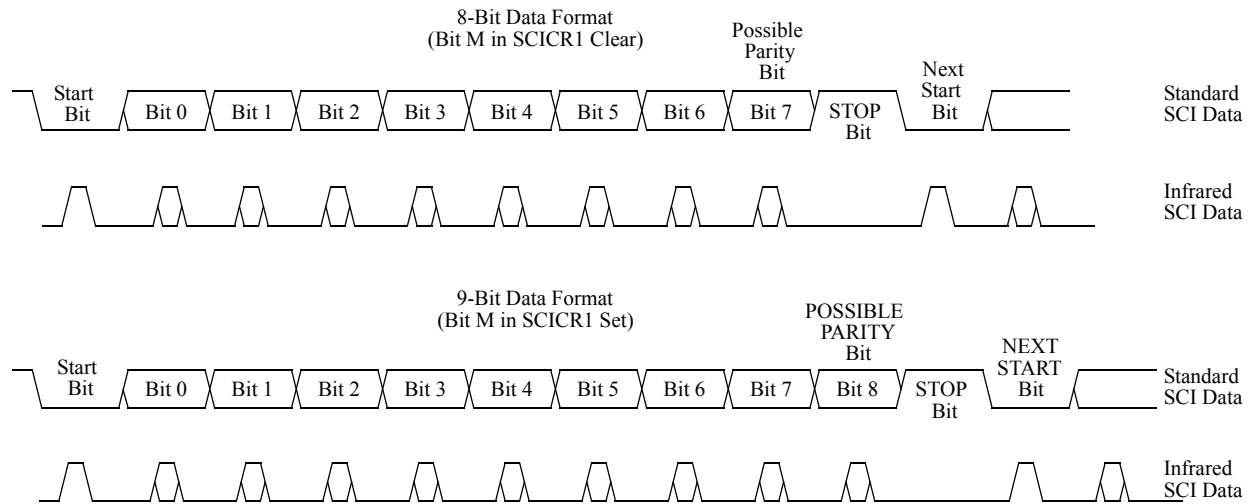


Figure 14-15. SCI Data Formats

Each data character is contained in a frame that includes a start bit, eight or nine data bits, and a stop bit. Clearing the M bit in SCI control register 1 configures the SCI for 8-bit data characters. A frame with eight data bits has a total of 10 bits. Setting the M bit configures the SCI for nine-bit data characters. A frame with nine data bits has a total of 11 bits.

Table 14-14. Example of 8-Bit Data Formats

Start Bit	Data Bits	Address Bits	Parity Bits	Stop Bit
1	8	0	0	1
1	7	0	1	1
1	7	1 ¹	0	1

¹ The address bit identifies the frame as an address character. See [Section 14.4.6.6, “Receiver Wakeup”](#).

When the SCI is configured for 9-bit data characters, the ninth data bit is the T8 bit in SCI data register high (SCIDRH). It remains unchanged after transmission and can be used repeatedly without rewriting it. A frame with nine data bits has a total of 11 bits.

Table 14-15. Example of 9-Bit Data Formats

Start Bit	Data Bits	Address Bits	Parity Bits	Stop Bit
1	9	0	0	1
1	8	0	1	1
1	8	1 ¹	0	1

Table 15-6. Example SPI Baud Rate Selection (25 MHz Bus Clock) (Sheet 3 of 3)

SPPR2	SPPR1	SPPR0	SPR2	SPR1	SPR0	Baud Rate Divisor	Baud Rate
1	1	0	1	0	0	224	111.61 kbit/s
1	1	0	1	0	1	448	55.80 kbit/s
1	1	0	1	1	0	896	27.90 kbit/s
1	1	0	1	1	1	1792	13.95 kbit/s
1	1	1	0	0	0	16	1.5625 Mbit/s
1	1	1	0	0	1	32	781.25 kbit/s
1	1	1	0	1	0	64	390.63 kbit/s
1	1	1	0	1	1	128	195.31 kbit/s
1	1	1	1	0	0	256	97.66 kbit/s
1	1	1	1	0	1	512	48.83 kbit/s
1	1	1	1	1	0	1024	24.41 kbit/s
1	1	1	1	1	1	2048	12.21 kbit/s

15.3.2.4 SPI Status Register (SPISR)

Module Base +0x0003

	7	6	5	4	3	2	1	0
R	SPIF	0	SPTEF	MODF	0	0	0	0
W								
Reset	0	0	1	0	0	0	0	0


 = Unimplemented or Reserved

Figure 15-6. SPI Status Register (SPISR)

Read: Anytime

Write: Has no effect

Table 15-7. SPISR Field Descriptions

Field	Description
7 SPIF	SPIF Interrupt Flag — This bit is set after received data has been transferred into the SPI data register. For information about clearing SPIF Flag, please refer to Table 15-8 . 0 Transfer not yet complete. 1 New data copied to SPIDR.

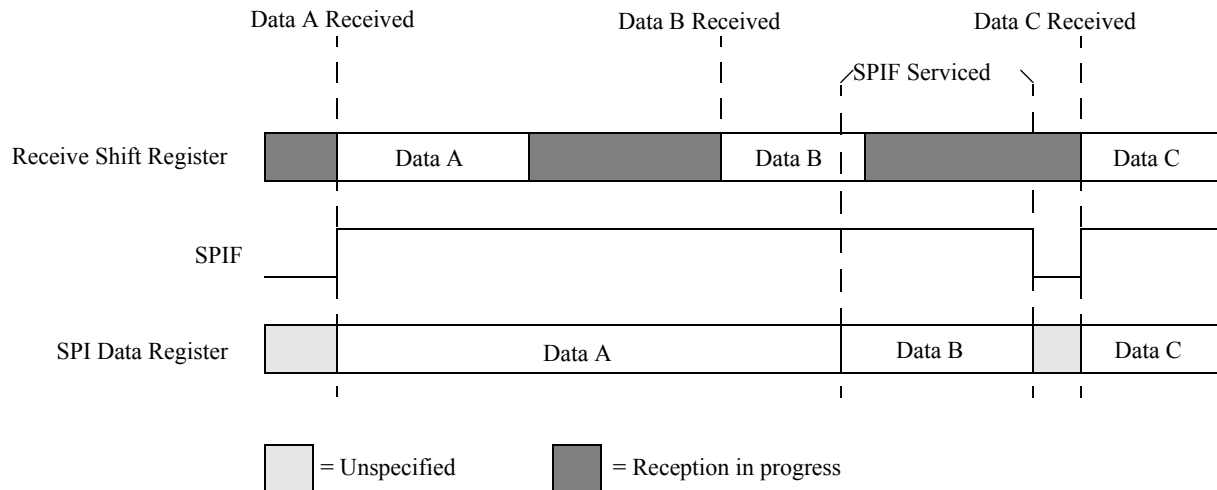


Figure 15-9. Reception with SPIF serviced in Time

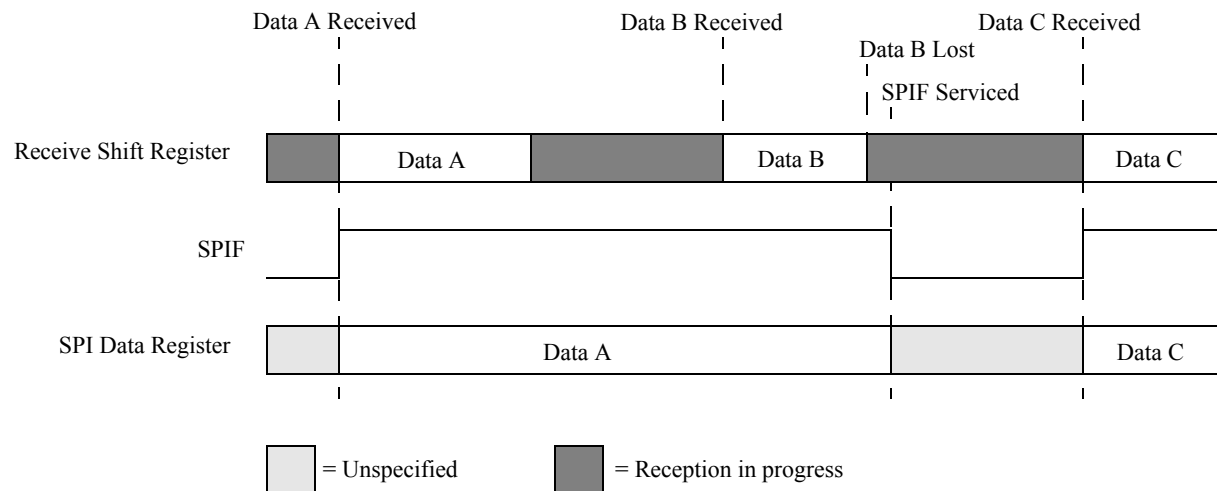


Figure 15-10. Reception with SPIF serviced too late

15.4 Functional Description

The SPI module allows a duplex, synchronous, serial communication between the MCU and peripheral devices. Software can poll the SPI status flags or SPI operation can be interrupt driven.

The SPI system is enabled by setting the SPI enable (SPE) bit in SPI control register 1. While SPE is set, the four associated SPI port pins are dedicated to the SPI function as:

- Slave select (\overline{SS})
- Serial clock (SCK)
- Master out/slave in (MOSI)
- Master in/slave out (MISO)

NOTE

When peripherals with duplex capability are used, take care not to simultaneously enable two receivers whose serial outputs drive the same system slave's serial data output line.

As long as no more than one slave device drives the system slave's serial data output line, it is possible for several slaves to receive the same transmission from a master, although the master would not receive return information from all of the receiving slaves.

If the CPHA bit in SPI control register 1 is clear, odd numbered edges on the SCK input cause the data at the serial data input pin to be latched. Even numbered edges cause the value previously latched from the serial data input pin to shift into the LSB or MSB of the SPI shift register, depending on the LSBFE bit.

If the CPHA bit is set, even numbered edges on the SCK input cause the data at the serial data input pin to be latched. Odd numbered edges cause the value previously latched from the serial data input pin to shift into the LSB or MSB of the SPI shift register, depending on the LSBFE bit.

When CPHA is set, the first edge is used to get the first data bit onto the serial data output pin. When CPHA is clear and the \overline{SS} input is low (slave selected), the first bit of the SPI data is driven out of the serial data output pin. After the n ¹ shift, the transfer is considered complete and the received data is transferred into the SPI data register. To indicate transfer is complete, the SPIF flag in the SPI status register is set.

NOTE

A change of the bits CPOL, CPHA, SSOE, LSBFE, MODFEN, SPC0, or BIDIROE with SPC0 set in slave mode will corrupt a transmission in progress and must be avoided.

15.4.3 Transmission Formats

During an SPI transmission, data is transmitted (shifted out serially) and received (shifted in serially) simultaneously. The serial clock (SCK) synchronizes shifting and sampling of the information on the two serial data lines. A slave select line allows selection of an individual slave SPI device; slave devices that are not selected do not interfere with SPI bus activities. Optionally, on a master SPI device, the slave select line can be used to indicate multiple-master bus contention.

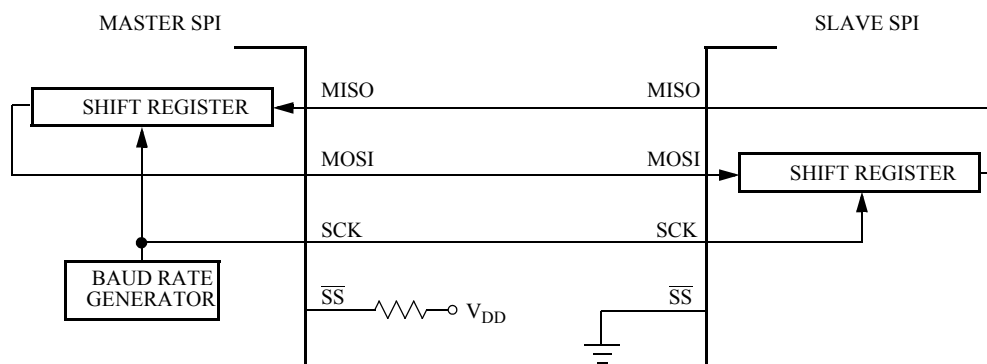


Figure 15-11. Master/Slave Transfer Block Diagram

1. n depends on the selected transfer width, please refer to [Section 15.3.2.2, “SPI Control Register 2 \(SPICR2\)”](#)

18.5 Initialization/Application Information

18.5.1 MSCAN initialization

The procedure to initially start up the MSCAN module out of reset is as follows:

1. Assert CANE
2. Write to the configuration registers in initialization mode
3. Clear INITRQ to leave initialization mode

If the configuration of registers which are only writable in initialization mode shall be changed:

1. Bring the module into sleep mode by setting SLPRQ and awaiting SLPK to assert after the CAN bus becomes idle.
2. Enter initialization mode: assert INITRQ and await INITAK
3. Write to the configuration registers in initialization mode
4. Clear INITRQ to leave initialization mode and continue

18.5.2 Bus-Off Recovery

The bus-off recovery is user configurable. The bus-off state can either be left automatically or on user request.

For reasons of backwards compatibility, the MSCAN defaults to automatic recovery after reset. In this case, the MSCAN will become error active again after counting 128 occurrences of 11 consecutive recessive bits on the CAN bus (see the Bosch CAN 2.0 A/B specification for details).

If the MSCAN is configured for user request (BORM set in **MSCAN Control Register 1 (CANCTL1)**), the recovery from bus-off starts after both independent events have become true:

- 128 occurrences of 11 consecutive recessive bits on the CAN bus have been monitored
- BOHOLD in **MSCAN Miscellaneous Register (CANMISC)** has been cleared by the user

These two events may occur in any order.

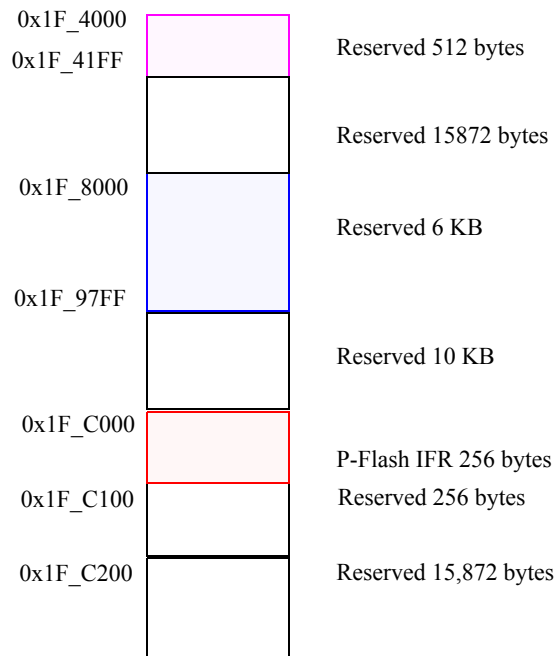


Figure 22-3. Memory Controller Resource Memory Map (NVM Resources Area)

22.3.2 Register Descriptions

The Flash module contains a set of 24 control and status registers located between Flash module base + 0x0000 and 0x0017.

In the case of the writable registers, the write accesses are forbidden during Flash command execution (for more detail, see Caution note in <st-blue>Section 22.3 Memory Map and Registers).

A summary of the Flash module registers is given in [Figure 22-4](#) with detailed descriptions in the following subsections.

Address & Name		7	6	5	4	3	2	1	0
0x0000 FCLKDIV	R	FDIVLD	FDIVLCK	FDIV5	FDIV4	FDIV3	FDIV2	FDIV1	FDIV0
	W								
0x0001 FSEC	R	KEYEN1	KEYEN0	RNV5	RNV4	RNV3	RNV2	SEC1	SEC0
	W								

Figure 22-4. FTMRZ192K2K Register Summary

In **Table D-2**, the timing characteristics for slave mode are listed.

Table D-2. SPI Slave Mode Timing Characteristics (Junction Temperature From -40°C To $+175^{\circ}\text{C}$)

Num	Characteristic	Symbol				Unit
			Min	Typ	Max	
1	SCK Frequency	f_{sck}	DC	—	1/4	f_{bus}
1	SCK Period	t_{sck}	4	—	∞	t_{bus}
2	Enable Lead Time	t_{lead}	4	—	—	t_{bus}
3	Enable Lag Time	t_{lag}	4	—	—	t_{bus}
4	Clock (SCK) High or Low Time	t_{wsck}	4	—	—	t_{bus}
5	Data Setup Time (Inputs)	t_{su}	8	—	—	ns
6	Data Hold Time (Inputs)	t_{hi}	8	—	—	ns
7	Slave Access Time (time to data active)	t_{a}	—	—	20	ns
8	Slave MISO Disable Time	t_{dis}	—	—	22	ns
9	Data Valid after SCK Edge	t_{vsck}	—	—	$30 + t_{\text{bus}}^1$	ns
10	Data Valid after $\overline{\text{SS}}$ fall	t_{vss}	—	—	$30 + t_{\text{bus}}^1$	ns
11	Data Hold Time (Outputs)	t_{ho}	20	—	—	ns
12	Rise and Fall Time Inputs	t_{rfi}	—	—	8	ns
13	Rise and Fall Time Outputs	t_{rfo}	—	—	8	ns

¹ t_{bus} added due to internal synchronization delay

